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INFORMATION DISCLOSURE					FILING DATE: August 22, 2001 CONFIRMA					
				FILING				TION NO.: 8935		
			PLICANT	APPLIC	ANT: Lieber, et al.					
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			FILING DATE:	August 22, 2001	CONFIRMATION NO.: 8935		
			APPLICANT:	Lieber, et al.			
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#EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.

*a copy of this reference is not provided as it was previously cited by or submitted to the office in a prior application, Serial No. ____ filed ____, and relied upon for an earlier

filing date under 35 U.S.C. 120 (continuation, continuation-in-part, and divisional applications). [NOTE - The Office hereby waives the requirement under 37 CFR 1.98 (a)(2)(i) for submitting a copy of each cited U.S. patent and each U.S. patent application publication for all U.S. national patent applications filed after June 30, 2003 and for all international applications that have entered the national stage under 35 USC 371 after June 30, 2003. See 37 CFR 1.491(b). For all patent applications filed on or before June 30, 2003, copies of cited U.S. patents and patent application publications are still required unless an eIDS is filed. Copies of all other patent(s), publication(s), or other information listed must still be provided, even if it was previously submitted to, or cited by, the U.S. Patent Office in an earlier application, unless the earlier application is identified by the IDS and is relied upon for an earlier filing date under 35 U.S.C. §120, and the copy was provided in the earlier application.]